

Global High Temperature Solder Pastes Market Data Survey Report 2025

https://marketpublishers.com/r/G3BC3376C1DEN.html

Date: April 2018

Pages: 77

Price: US\$ 1,500.00 (Single User License)

ID: G3BC3376C1DEN

Abstracts

SUMMARY

The global High Temperature Solder Pastes market will reach Million USD in 2018 with CAGR xx% 2018-2025. The main contents of the report including:

Global market size and forecast

Regional market size, production data and export & import

Key manufacturers (manufacturing sites, capacity and production, product specifications etc.)

Major Application

Major Type

Key manufacturers are included based on manufacturing sites, capacity and production, product specifications etc.:

FCT Solder

Indium Corporation

Nordson Corporation



Interflux Electronics

Kester
Inventec
Inventec
Major applications as follows:
SMT Assembly
Semiconductor Packaging
Major Type as follows:
Rosin Based Pastes
Water Soluble Pastes
Others
Regional market size, production data and export & import:
Asia-Pacific
North America
Europe
South America
Middle East & Africa



Contents

1 GLOBAL MARKET OVERVIEW

- 1.1 Scope of Statistics
 - 1.1.1 Scope of Products
 - 1.1.2 Scope of Manufacturers
 - 1.1.3 Scope of Application
 - 1.1.5 Scope of Regions/Countries
- 1.2 Global Market Size

2 REGIONAL MARKET

- 2.1 Regional Production
- 2.2 Regional Demand
- 2.3 Regional Trade

3 KEY MANUFACTURERS

- 3.1 FCT Solder
 - 3.1.2 Company Information
 - 3.1.2 Product Specifications
 - 3.1.3 Business Data (Capacity, Sales Revenue, Volume, Price, Cost and Margin)
- 3.2 Indium Corporation
 - 3.2.1 Company Information
 - 3.2.2 Product Specifications
 - 3.2.3 Business Data (Capacity, Sales Revenue, Volume, Price, Cost and Margin)
- 3.3 Nordson Corporation
 - 3.3.1 Company Information
 - 3.3.2 Product Specifications
 - 3.3.3 Business Data (Capacity, Sales Revenue, Volume, Price, Cost and Margin)
- 3.4 Interflux Electronics
 - 3.4.1 Company Information
 - 3.4.2 Product Specifications
 - 3.4.3 Business Data (Capacity, Sales Revenue, Volume, Price, Cost and Margin)
- 3.5 Kester
 - 3.5.1 Company Information
 - 3.5.2 Product Specifications
 - 3.5.3 Business Data (Capacity, Sales Revenue, Volume, Price, Cost and Margin)



- 3.6 Invented
 - 3.6.1 Company Information
 - 3.6.2 Product Specifications
 - 3.6.3 Business Data (Capacity, Sales Revenue, Volume, Price, Cost and Margin)
- 3.7 Inventec
 - 3.7.1 Company Information
 - 3.7.2 Product Specifications
 - 3.7.3 Business Data (Capacity, Sales Revenue, Volume, Price, Cost and Margin)

4 MAJOR APPLICATION

- 4.1 SMT Assembly
 - 4.1.1 Overview
 - 4.1.2 SMT Assembly Market Size and Forecast
- 4.2 Semiconductor Packaging
 - 4.2.1 Overview
 - 4.2.2 Semiconductor Packaging Market Size and Forecast

5 MARKET BY TYPE

- 5.1 Rosin Based Pastes
 - 5.1.1 Overview
 - 5.1.2 Rosin Based Pastes Market Size and Forecast
- 5.2 Water Soluble Pastes
 - 5.2.1 Overview
 - 5.2.2 Water Soluble Pastes Market Size and Forecast
- 5.3 Others
 - 5.3.1 Overview
 - 5.3.2 Others Market Size and Forecast

6 CONCLUSION



List Of Tables

LIST OF TABLES

Tab Regional Production 2011-2017 (Million USD)

Tab Regional Demand and CAGR 2011-2017 (Million USD)

Tab Regional Demand Forecast and CAGR 2018-2025 (Million USD)

Tab Regional Export 2011-2017 (Million USD)

Tab Regional Import 2011-2017 (Million USD)

Tab Sales Revenue, Cost and Margin of FCT Solder

Tab Sales Revenue, Cost and Margin of Indium Corporation

Tab Sales Revenue, Cost and Margin of Nordson Corporation

Tab Sales Revenue, Cost and Margin of Interflux Electronics

Tab Sales Revenue, Cost and Margin of Kester

Tab Sales Revenue, Cost and Margin of Inventec

Tab Sales Revenue, Cost and Margin of Inventec



List Of Figures

LIST OF FIGURES

Fig Global High Temperature Solder Pastes Market Size and CAGR 2011-2017 (Million USD)

Fig Global High Temperature Solder Pastes Market Forecast and CAGR 2018-2025 (Million USD)

Fig SMT Assembly Market Size and CAGR 2011-2017 (Million USD)

Fig SMT Assembly Market Forecast and CAGR 2018-2025 (Million USD)

Fig Semiconductor Packaging Market Size and CAGR 2011-2017 (Million USD)

Fig Semiconductor Packaging Market Forecast and CAGR 2018-2025 (Million USD)

Fig Rosin Based Pastes Market Size and CAGR 2011-2017 (Million USD)

Fig Rosin Based Pastes Market Forecast and CAGR 2018-2025 (Million USD)

Fig Water Soluble Pastes Market Size and CAGR 2011-2017 (Million USD)

Fig Water Soluble Pastes Market Forecast and CAGR 2018-2025 (Million USD)

Fig Others Market Size and CAGR 2011-2017 (Million USD)

Fig Others Market Forecast and CAGR 2018-2025 (Million USD)



I would like to order

Product name: Global High Temperature Solder Pastes Market Data Survey Report 2025

Product link: https://marketpublishers.com/r/G3BC3376C1DEN.html

Price: US\$ 1,500.00 (Single User License / Electronic Delivery)

If you want to order Corporate License or Hard Copy, please, contact our Customer

Service:

info@marketpublishers.com

Payment

First name:

To pay by Credit Card (Visa, MasterCard, American Express, PayPal), please, click button on product page https://marketpublishers.com/r/G3BC3376C1DEN.html

To pay by Wire Transfer, please, fill in your contact details in the form below:

Last name:	
Email:	
Company:	
Address:	
City:	
Zip code:	
Country:	
Tel:	
Fax:	
Your message:	
	**All fields are required
	Custumer signature

Please, note that by ordering from marketpublishers.com you are agreeing to our Terms & Conditions at https://marketpublishers.com/docs/terms.html

To place an order via fax simply print this form, fill in the information below and fax the completed form to +44 20 7900 3970